

#### Features

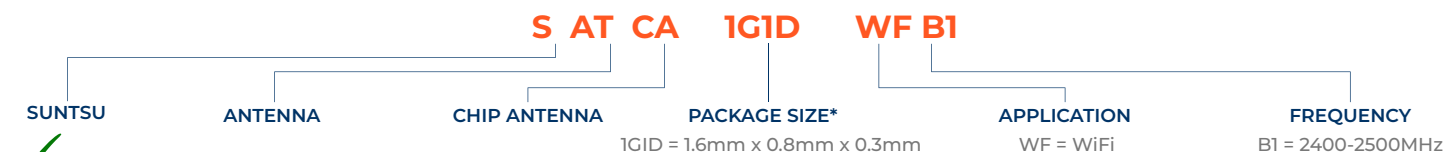
- WiFi/ZigBee/Bluetooth
- Chip Type
- Stable And Reliable Performance
- 2400-2500MHz
- SMT Process Compatible

#### Applications

- ISM 2.4 GHz Applications
- ZigBee/BLE Applications
- Bluetooth Earphone Systems
- Smart Hand Held Devices
- Machine To Machine Communication



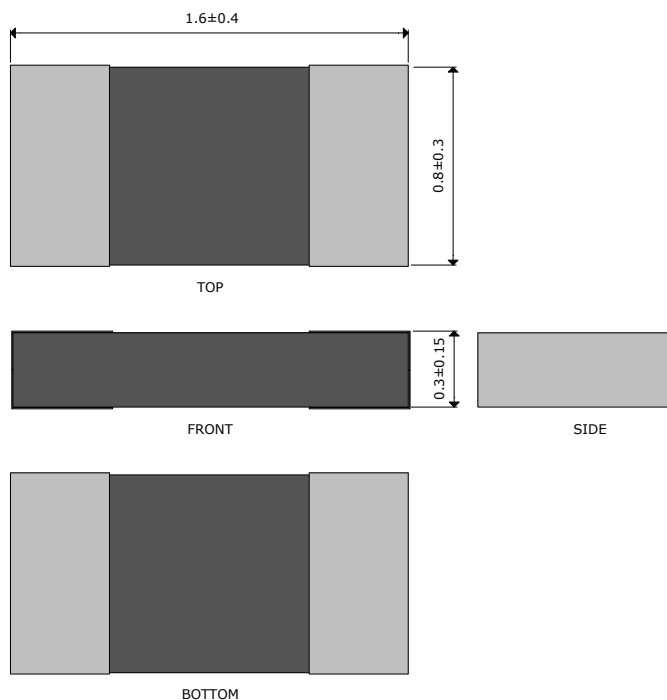
#### Part Numbering Guide



Electrical Parameters	Units	Minimum	Typical	Maximum	Remarks
Frequency Band	MHz	2400		2500	
Impedance	$\Omega$		50		
Polarization			Linear		
Peak Gain	dBi		-0.3		At 2442MHz
Efficiency	%		60		At 2442MHz
VSWR				2.5	At Center Frequency
Operating Temperature	C	-40		85	

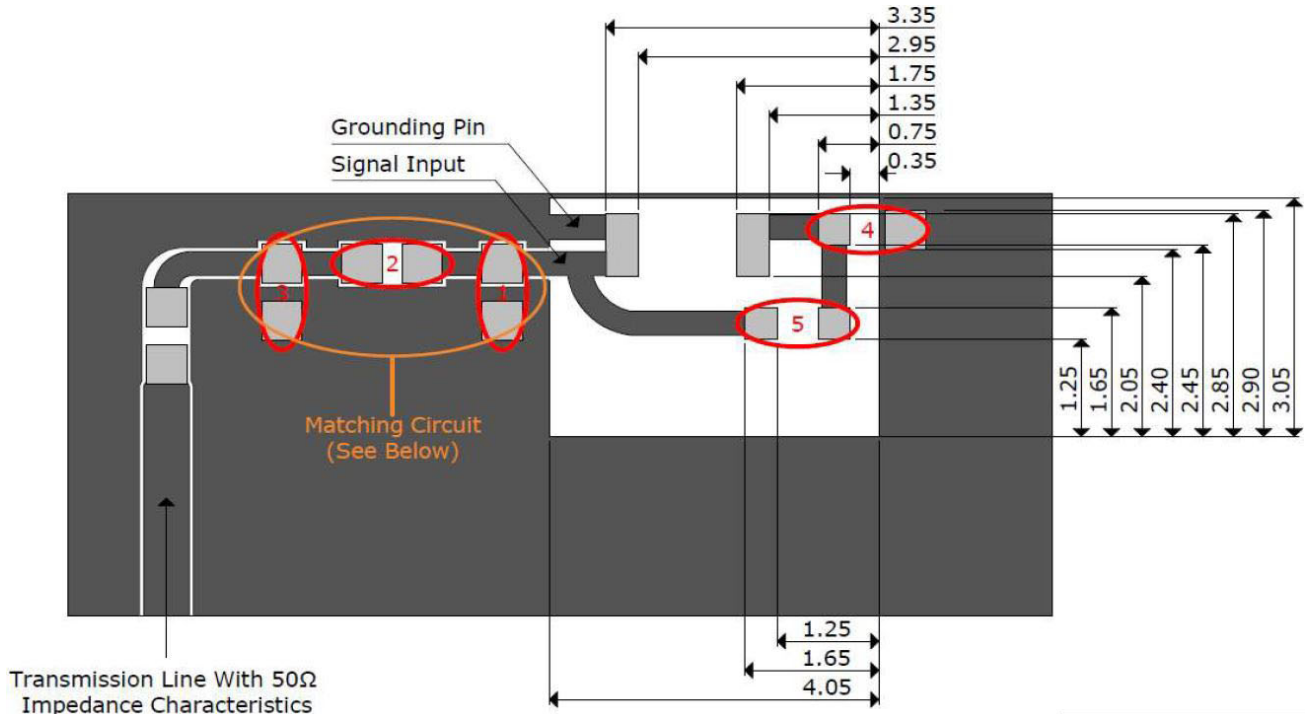
#### Outline Drawing

All dimensions are in millimeters (mm) unless otherwise noted. Drawings are not to scale.



### Recommended Land Pattern & Frequency Tuning Scenario Circuit

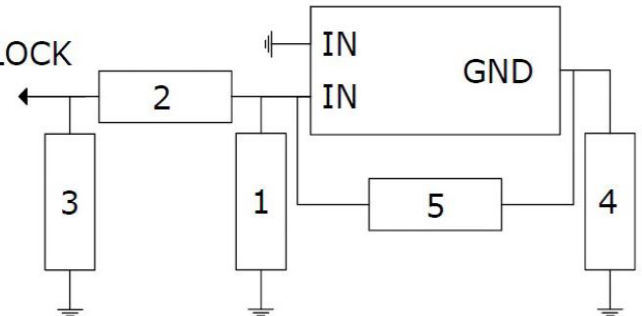
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System Matching Circuit Components

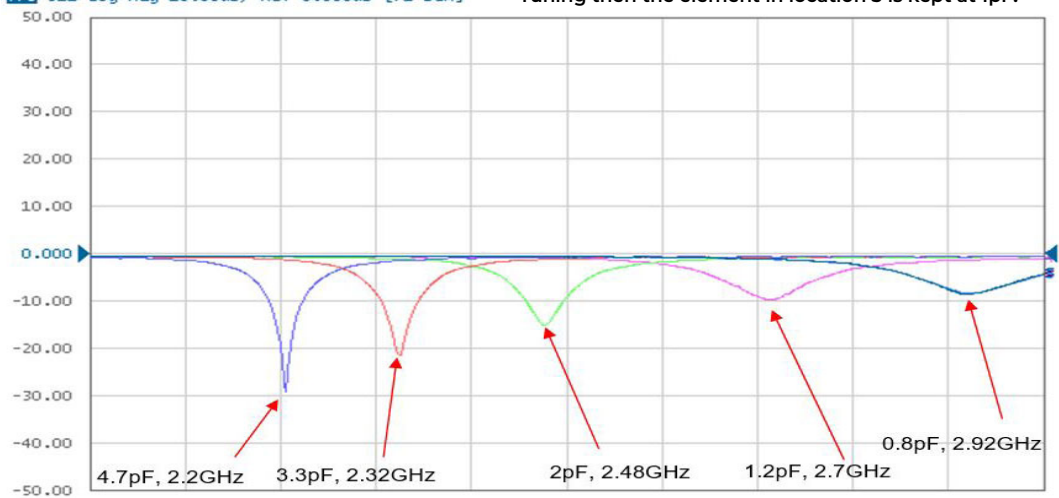
Location	Description	Vendor	Tolerance
1	N/A	-	-
2	0Ω, (0402)	-	-
3	N/A	-	-
4 (Fine Tuning)	2.2pF, (0402)	DARFON	±0.1pF
5 (Fine Tuning)	1.2pF, (0402)	DARFON	±0.1pF

DC BLOCK



The below chart is for reference of Frequency Tuning then the element in location 5 is kept at 1pF.

Tr1 S11 Log Mag 10.00dB/ Ref 0.000dB [F1 D&M]  
Tr2 S11 Log Mag 10.00dB/ Ref 0.000dB [F1 D&M]  
Tr3 S11 Log Mag 10.00dB/ Ref 0.000dB [F1 D&M]  
Tr4 S11 Log Mag 10.00dB/ Ref 0.000dB [F1 D&M]  
Tr5 S11 Log Mag 10.00dB/ Ref 0.000dB [F1 D&M]

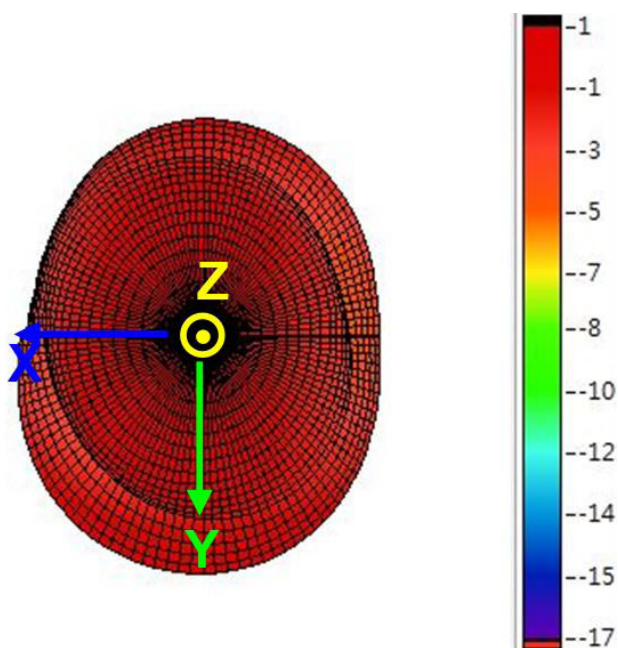


For these suggested values for the matching and tuning of components, the average frequency will be 2442MHz on a standard 40 x 20mm<sup>2</sup> Evaluation board.

Please note, these are average reference values which may need to be changed when different circuit boards or manufactures are used.

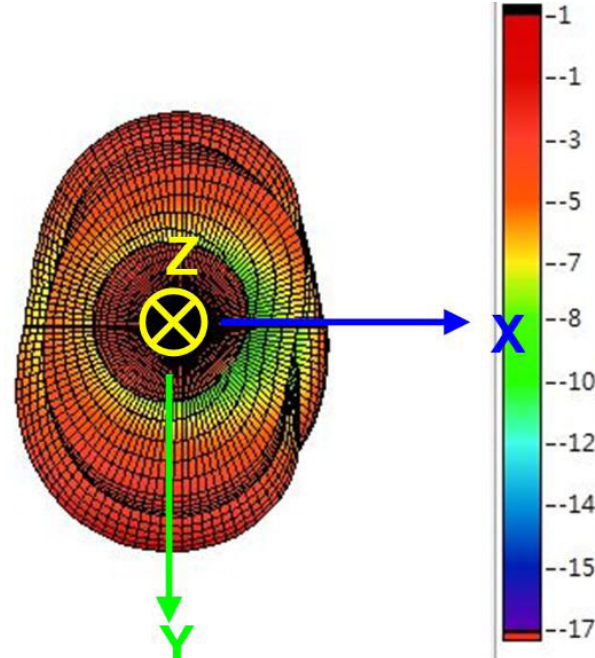
Radiation Pattern

2442MHz



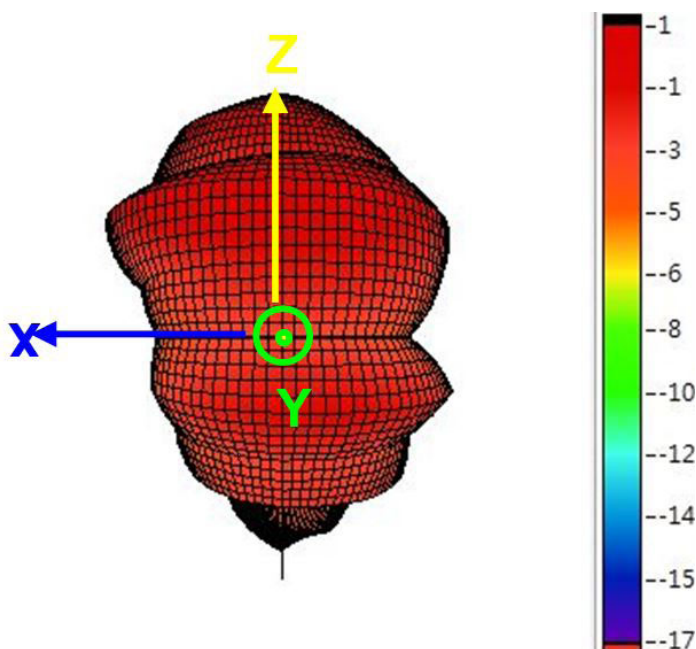
Radiation Pattern

2442MHz



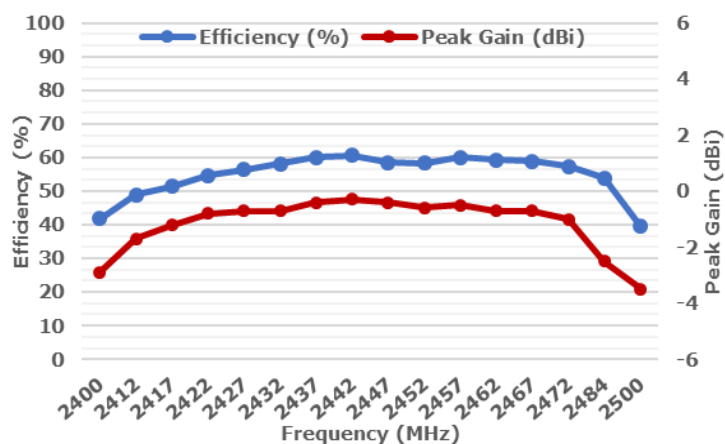
Radiation Pattern

2442MHz



Efficiency V's Frequency

2442MHz

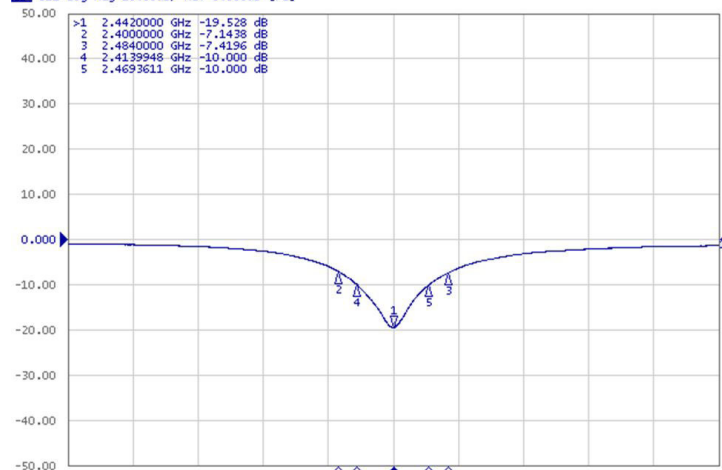


Freq.	2400	2412	2417	2422	2427	2432	2437	2442	2447	2452	2457	2462	2467	2472	2484	2500
Eff. (%)	41.8	48.9	51.4	54.6	56.5	58.1	60.1	60.7	58.6	58.3	60	59.2	59	57.4	53.9	39.5
P.G.(dBi)	-2.9	-1.7	-1.2	-0.8	-0.7	-0.7	-0.4	-0.3	-0.4	-0.6	-0.5	-0.7	-0.7	-1	-2.5	-3.5

### Electrical Test

#### Return Loss

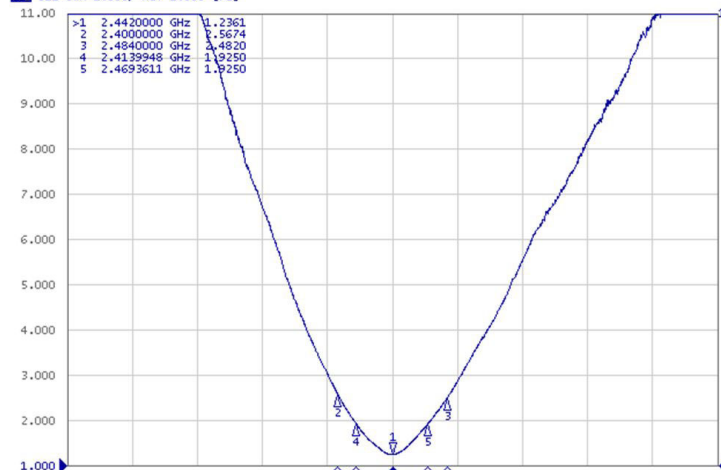
[F2] S11 Log Mag 10.00dB/ Ref 0.000dB [F2]



### Electrical Test

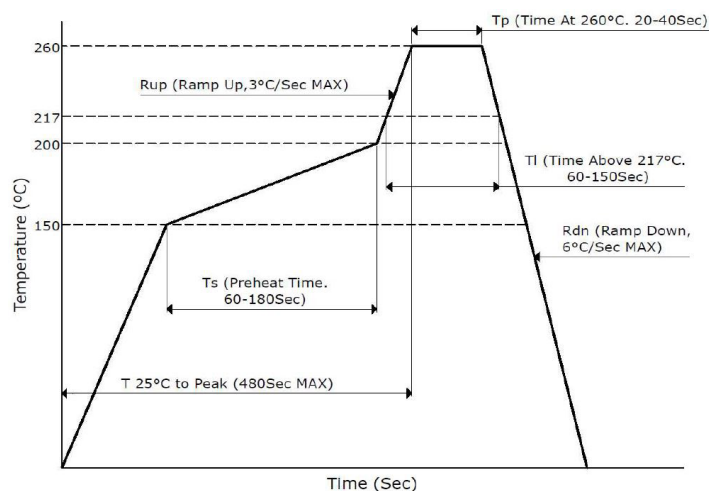
#### VSWR

[F2] S11 SWR 1.000/ Ref 1.000 [F2]



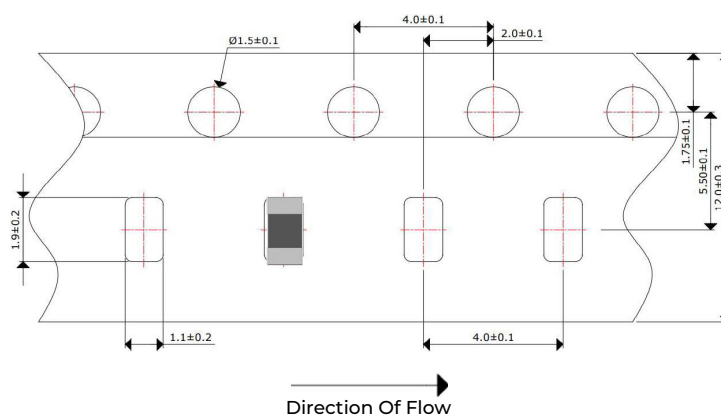
### Soldering Conditions

#### Typical Soldering Profile For Lead-Free Process



### Packaging - Tape And Reel

#### 5000Pcs / Reel



### Environmental & Mechanical Specifications

High Temperature Test	85°C for 500 hours, and then to normal temperature/humidity for 24hours.
Low Temperature Test	-30°C for 500 hours, and then to normal temperature/humidity for 24hours.
Humidity Test	85°C / 90-95%RH for 96 hours, and then to normal temperature/humidity for 24hours.
Thermal Shock Test	-30°C for 30 min and +85°C for 30 min. 5 cycles, then expose to normal temperature/humidity for 24 hours or more.
Vibration Test	5 to 200 to 5Hz, swept in 10min, 4.5G at max(2mm amplitude), in X and Y directions for 2 hours each and in Z direction for 4 hours.